ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Par	PC. Bannockl	burn. Illinois. A	Il rights reserved nations.	under both	This docume level parts, t	ent is a declaration en declaration	on of the su	bstances all lower	within the manufact level materials for	urer listed which the	item. Note: manufacture	if the item is an as er has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 StandardFormhttp://www.ipc.org/IPC-175xDistribution				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Infor					Mfg Informa	tion			
upplier Information														
ompany name* Company			npany unique ID			Unique ID Authority				Respo	Response Date*			
nsemi							20			2023-0	2023-06-12			
ttact Name Title - Contact				Phone - Contact*				Email - Contact*						
Product-Env-Stewards Product Envir			wiro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representative			esentative			Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards Product En			duct Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
	LE24CE	LE24CB642MC-AE SC		SOP I2C EEPROM(64K)		2023-06-12					82.16	mg	Each	
Ianufacturing Proccess Informa	tion													
Terminal Plating / Grid Array M	aterial	Ferminal Base A	Alloy J-STD-020 MSL		Rating	Peak Proce	Process Body Temperat		ure Max Time at Peak Temper		ature Num	ber of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Allo		CU Alloy	3			260 C		С	30	seco	onds 3			
omments														
TTENTION: MSL 3 Rated item require	s Bake and I	Dry Pack (after	electrical test)											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl bhthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.1	mg	Supplier	Silicon (Si)	7440-21-3		1.0932	mg
			Supplier	Polyimide	Proprietary Data		0.0068	mg
Die Attach	0.12	mg	Supplier	Silver (Ag)	7440-22-4		0.084	mg
			Supplier	Epoxy resins	129915-35-1		0.036	mg
Lead Frame	34.98	mg	Supplier	Silver (Ag)	7440-22-4		0.6786	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0385	mg
			Supplier	Iron (Fe)	7439-89-6		0.8045	mg
			Supplier	Copper (Cu)	7440-50-8		33.4514	mg
			Supplier	Phosphorus (P)	7723-14-0		0.007	mg
Mold Compound-Black	44.44	mg		Epoxy Phenol Resin	proprietary data		6.2216	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		38.2184	mg
Plating	1.36	mg	Supplier	Tin (Sn)	7440-31-5		1.36	mg
Wire Bond - Au	0.16	mg	Supplier	Gold (Au)	7440-57-5		0.16	mg